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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/751,131 Confirmation No. 1733  
Applicant : Cetiner et al.  
Filing Date : December 31, 2003  
Title : MEMS FABRICATION ON A LAMINATED SURFACE  
Group Art Unit : 2821  
Examiner : Tho Gia Phan  
Docket No. : 703538.4027  
Customer No. : 34313

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Sir:

This paper is filed in response to the Office Action dated May 17, 2005. Please amend the above-identified application as follows.

The amendments to the Claims appear in a listing of the claims, which begins on page 2 of this paper.

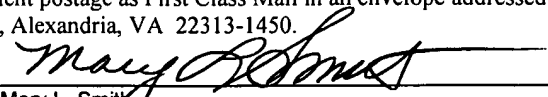
Remarks begin on page 6 of this paper.

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CERTIFICATE OF MAILING  
(37 CFR §1.8a)

I have reasonable basis to expect that this paper (along with any referred to as being attached or enclosed) would be mailed from the United States Postal Service on the date indicated with sufficient postage as First Class Mail in an envelope addressed to Mail Stop AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: July 26, 2005

  
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Mary L. Smith